



GAU 1765

PATENT  
Attorney Docket No. 01-099

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: )  
Rongxiang Hu, Philippe Schoenborn, )  
and Masaichi Eda )  
Serial No. 09/928,570 )  
Filed: August 13, 2001 )  
For: HIGH SELECTIVELY SiC ETCH )  
IN INTEGRATED CIRCUIT )  
FABRICATION )

Group Art Unit: 1765

Confirmation No. 7873

Examiner: L. Umez-Eronini

RECEIVED  
JUL 28 2003  
GROUP 1700

CERTIFICATE OF MAILING BY FIRST CLASS MAIL

Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

Sir:

The undersigned hereby certifies that the attached Response to Notice of Non-Compliant Amendment; revised Amendment and Response to First Office Action; Certificate of Mailing by First Class Mail; and Return Card, relating to the above application, were deposited as "First Class Mail," with the United States Postal Service, addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 22nd day of July, 2003.

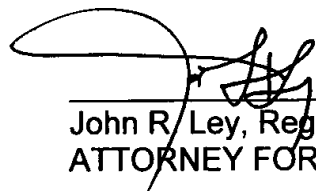
7/22/03

Date

  
Mailer

7/22/03

Date



John R. Ley, Registration No. 27,453  
ATTORNEY FOR APPLICANT

JOHN R. LEY, LLC  
5299 DTC Boulevard, Suite 610  
Greenwood Village, Colorado 80111-3327  
Telephone: (303) 740-9000  
Facsimile: (303) 740-9042